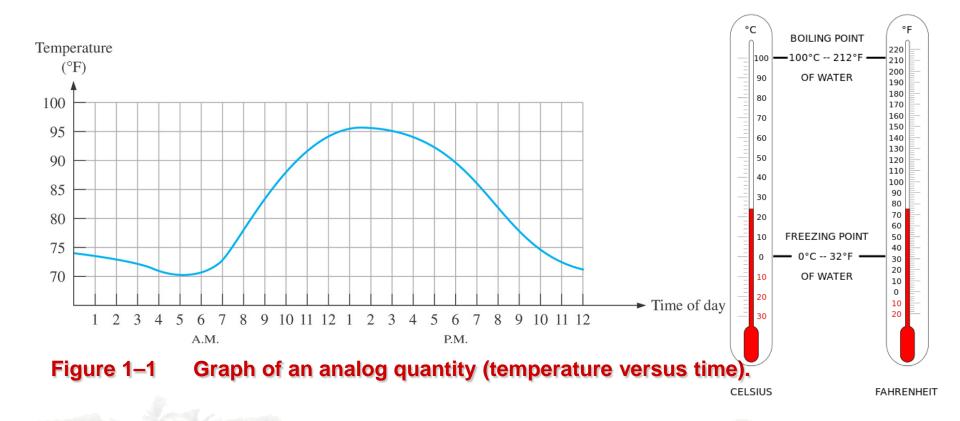
Chapter 1 Introduction to Digital System Design

Digital vs. Analog

Examples

- Thermometer
- Photography
- Audio System
- Storage
- Information Processing

Example I: Thermometer



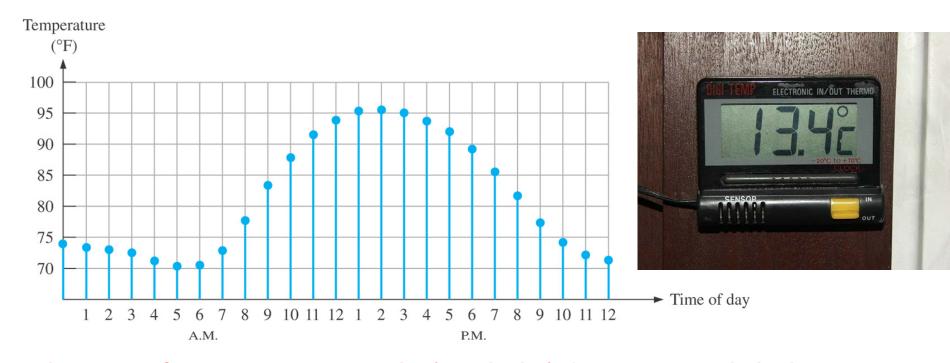
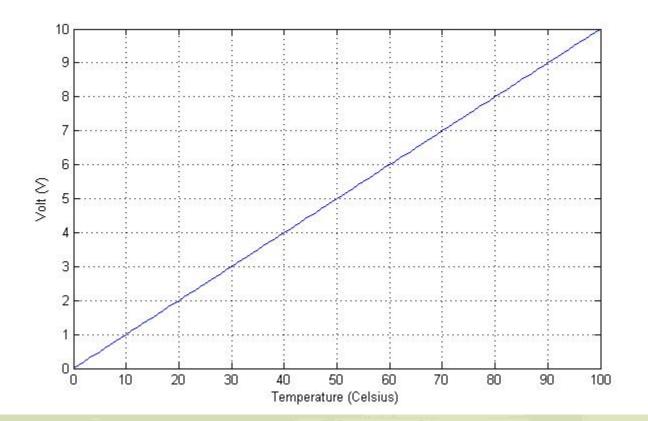


Figure 1–2 Sampled-value representation (quantization) of the analog quantity in Figure 1–1. Each value represented by a dot can be digitized by representing it as a digital code that consists of a series of 1s and 0s.

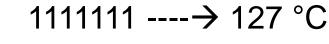
An Example

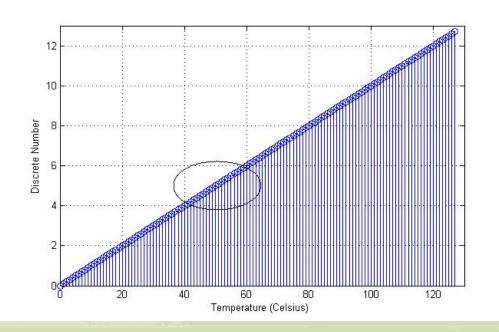
- Analog thermometer
 - 0V to 10V, could be used to represent 0°C to 100°C
 - Each 1/10 volt represents 1 degree

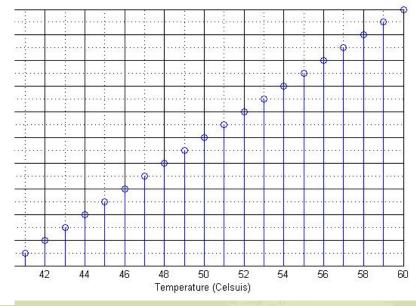


• Digital thermometer

- 7-bit binary number could be used to represent 0°C to 127° C
- 0000000 ----→ 0°C; 0000001 ----→ 1°C;

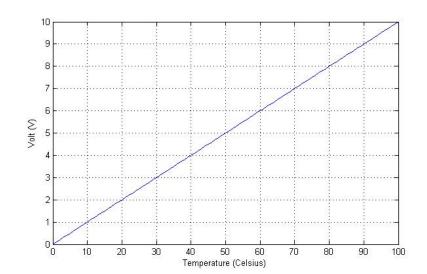


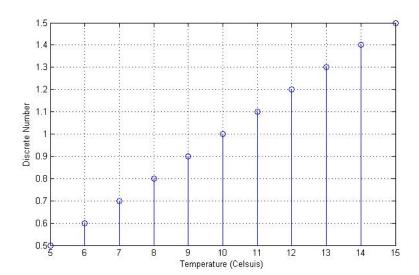




Digital Precision

- How would you represent 10.5° C?
- Analog example: 1.05V
- Digital example:
 - $-0001010_2 = 10_{10} - \rightarrow 10^{\circ}\text{C}$
 - $-0001011_2 = 11_{10} - \rightarrow 11^{\circ}C$
 - We must either add bits or decrease the range





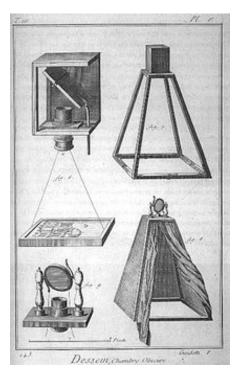
Digital Precision

- 9-bit thermometer, 0° to 127.75° C
 - Each discrete number increase represents 0.25° C
 - $-10.5^{\circ} \text{ C} \rightarrow 10.5/0.25 = 42 = 000101010_{2}$
- 7-bit thermometer, 0° to 12.7° C
 - Each discrete number represents $12.7^{\circ}/127 = 0.1^{\circ}$ C
 - $-10.5^{\circ} \text{ C} \rightarrow 10.5/0.1 = 105 = 1101001_{2}$
- It is impossible to represent *all* values exactly using digital representation
 - Example: 1/3 can't be represented in binary, just like it can't be represented in decimal

Example II: Photography

- Analog photography
 - An analog camera uses a chemical reaction in the film when exposed to light
 - The amount of exposure is directly related to the amount of light that hits the film

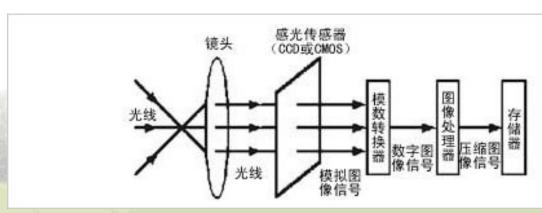






Digital Photography

- A digital camera uses an array of light-sensitive receptors that measures the light as a binary number
- Image quality is determined mostly by two factors:
 - The number of bits per pixel
 - The number of pixels per image







Example: Digital Photography



1284x897 pixels, 24-bit color



1284x897 pixels, 6-bit color



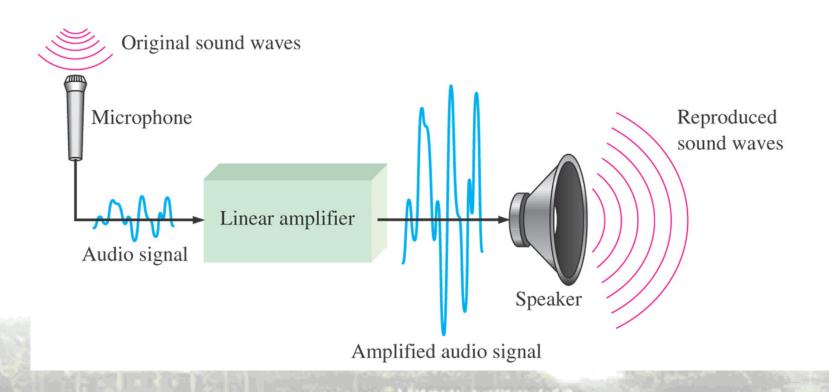
100x70 pixels, 24-bit color



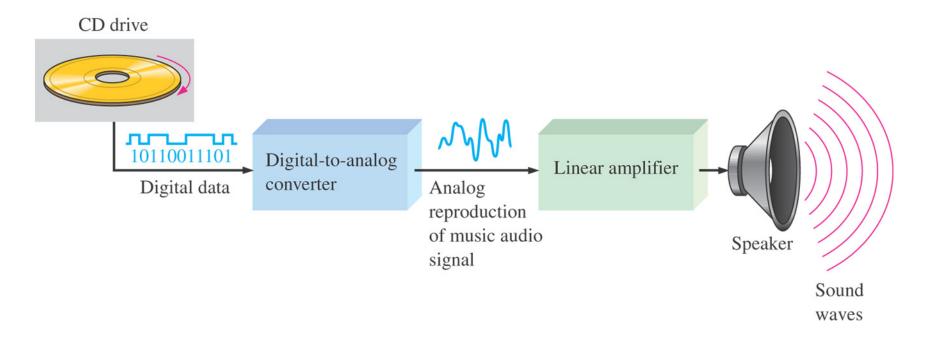
100x70 pixels, 6-bit color

Example III: Audio System

A basic audio public address system.



Basic block diagram of a CD player.



Example IV: Storage

- Analog storage mediums fade over time due to gradual physical degradation
 - Photos turn yellow with time
 - Cassette audio tapes lose their clarity





Example IV: Storage

- Digital storage mediums don't "fade" like analog
 - If a 0 or 1 fades it will still be a 0 or 1
 - A .jpg image taken 10 years ago is exactly the same today









Analog vs. Digital Storage

- Making an analog copy implies measuring the storage medium
 - Always introduces some errors
 - Copies of copies are even worse
- Making digital copies implies distinguishing 0's from 1's so copies are exact
 - Copies can be made without any error
 - Copies of copies are identical

Example V: Analog vs. Digital Processing

- Modern computers and digital circuits make it easy to do extremely complex processing
- Digital processing allows precision and error to be exactly predicted

1-1 Digital and Analog Quantities

- Analog quantity: having continuous values
 - Analog systems represent information using physical quantities
 - Voltage on a wire, magnetic field strength
- Digital quantity: having a discrete set of values
 - Digital systems represent information using binary digits, or *bits*
 - 1 or 0, high or low, on or off

How to represent digital quantity?

-- Positional Number Systems

- Two discrete values are insufficient for most applications
- We combine bits to represent more values
- We use a positional number system for binary just like we do in decimal

Positional Number Systems

- *Decimal*, base 10, means we have 10 digits (0-9)
 - Example:

$$1032_{10} = 1 \times 10^3 + 0 \times 10^2 + 3 \times 10^1 + 2 \times 10^0$$

- *Hexadecimal*, base 16, means we have 16 digits (0-9, A-F)
 - Example:

$$2A5_{16} = 2 \times 16^2 + 10 \times 16^1 + 5 \times 16^0 = 512 + 160 + 5 = 677$$

- *Binary*, base 2, follows the same pattern
 - Example:

$$1011_2 = 1 \times 2^3 + 0 \times 2^2 + 1 \times 2^1 + 1 \times 2^0 = 8 + 0 + 2 + 1 = 11$$

Counting in any base is analogous to counting in decimal

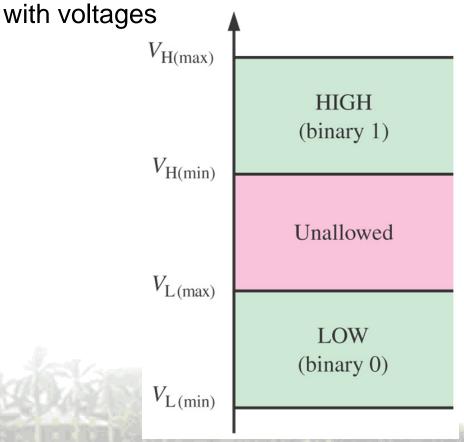
1-2 Binary Digits, Logic Levels, and Digital Waveforms

- Binary Digits
 - Positive logic
 - '1' is represented by HIGH
 - '0' is represented by LOW
 - Negative logic
 - Groups of bits: codes

Logic Level

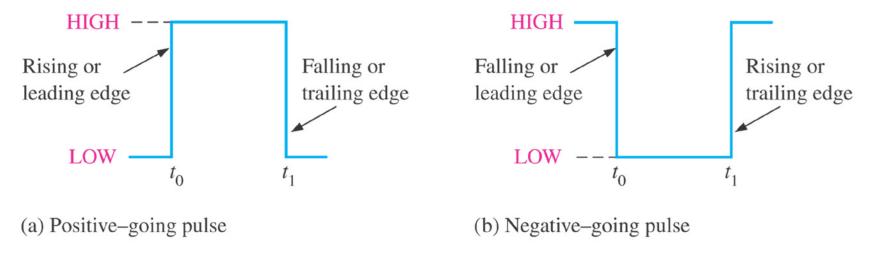
Logic levels: the voltages used to represent a '1' and a '0'

This figure answers the question how to represent the binary logic

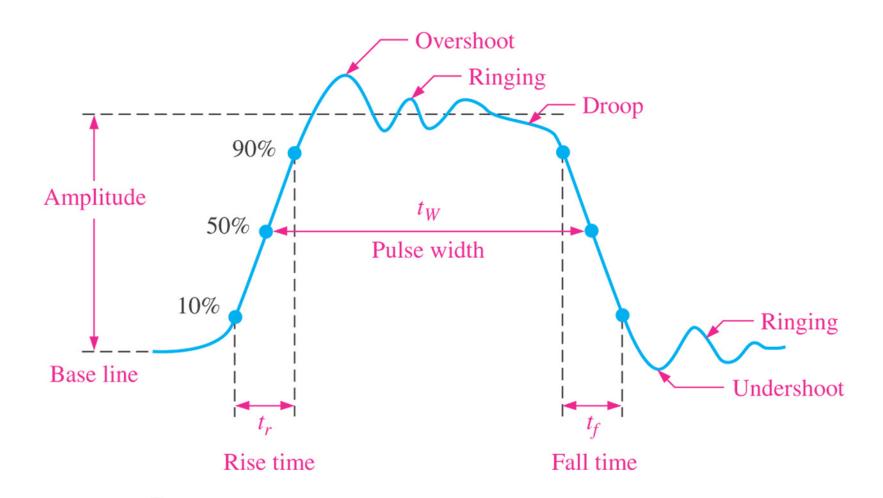


Logic level ranges of voltage for a digital circuit.

• Digital Waveforms



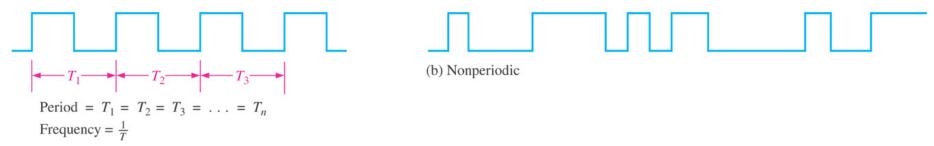
Ideal pulses



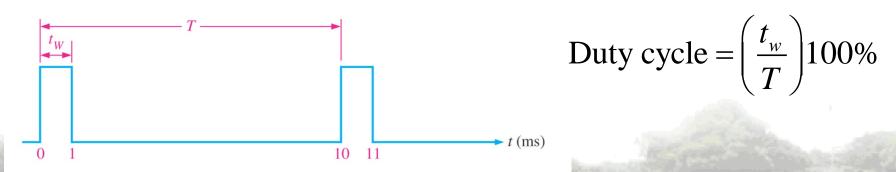
Nonideal pulse characteristics.

Waveform characteristics

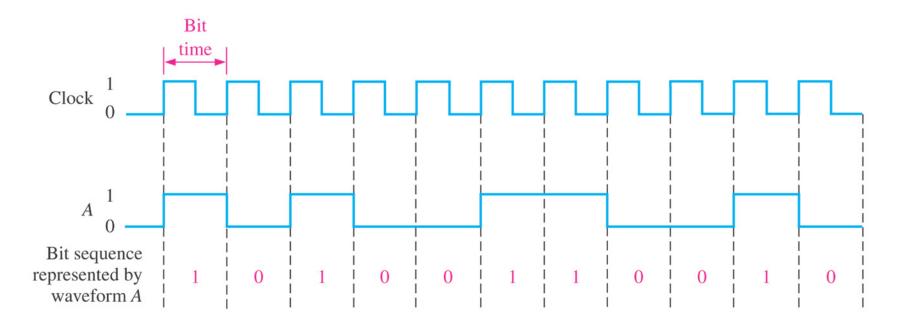
- Period (周期)
- Frequency (频率)
- Duty cycle (占空比)



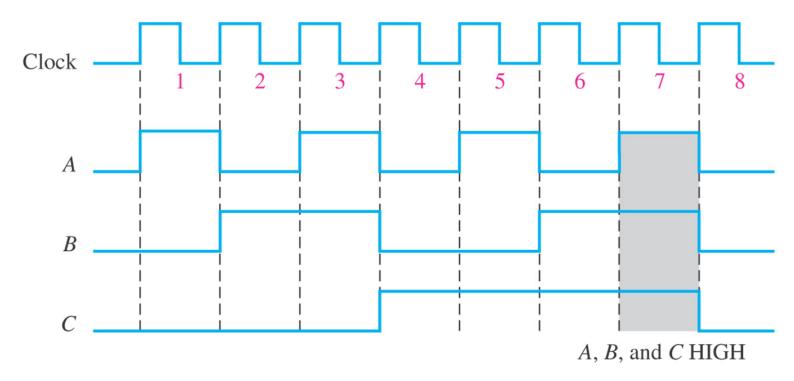
(a) Periodic (square wave)



A Digital Waveform Carries Binary Information



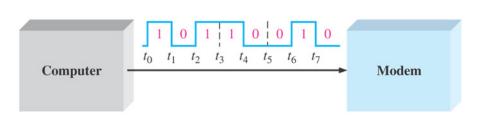
Example of a clock waveform synchronized with a waveform representation of a sequence of bits.



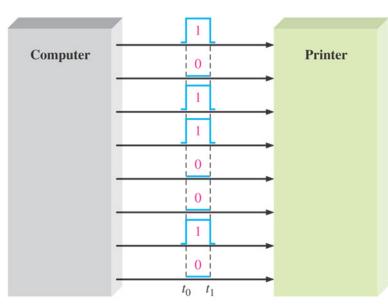
Example of a timing diagram.

Data Transfer

- Serial transfer (串行传输)
- Parallel transfer (并行传输)



(a) Serial transfer of 8 bits of binary data from computer to modem. Interval t_0 to t_1 is first.

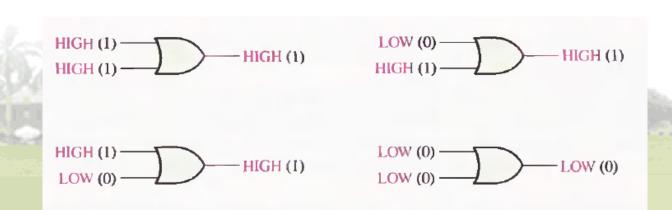


(b) Parallel transfer of 8 bits of binary data from computer to printer. The beginning time is t_0 .

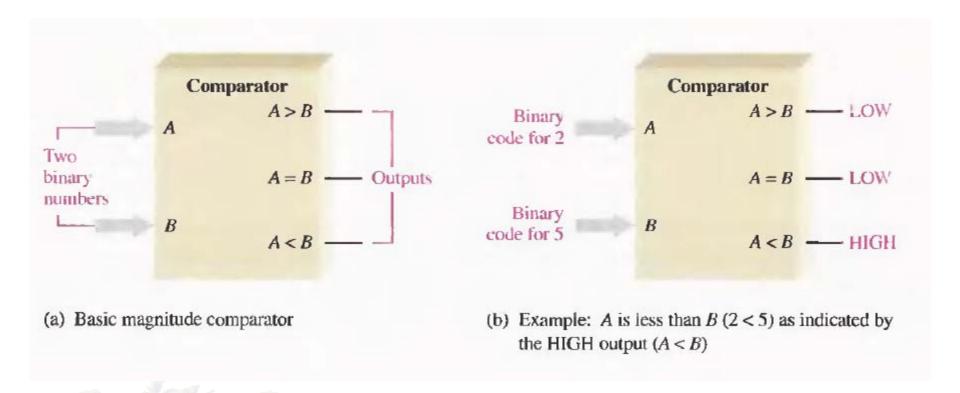
Illustration of serial and parallel transfer of binary data. Only the data lines are shown.

1-3 Basic Logic Operations

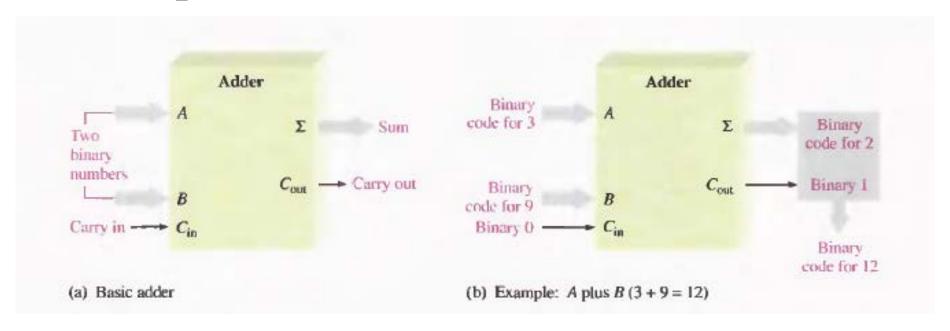
NOT LOW (0) — HIGH (1) — -- LOW (0) **AND** HIGH (1) -LOW (0) -LOW (0) - HIGH (1) HIGH(1)-HIGH (1) HIGH(1) LOW (0) - LOW (0) LOW (0) LOW (0) -LOW (0) -OR



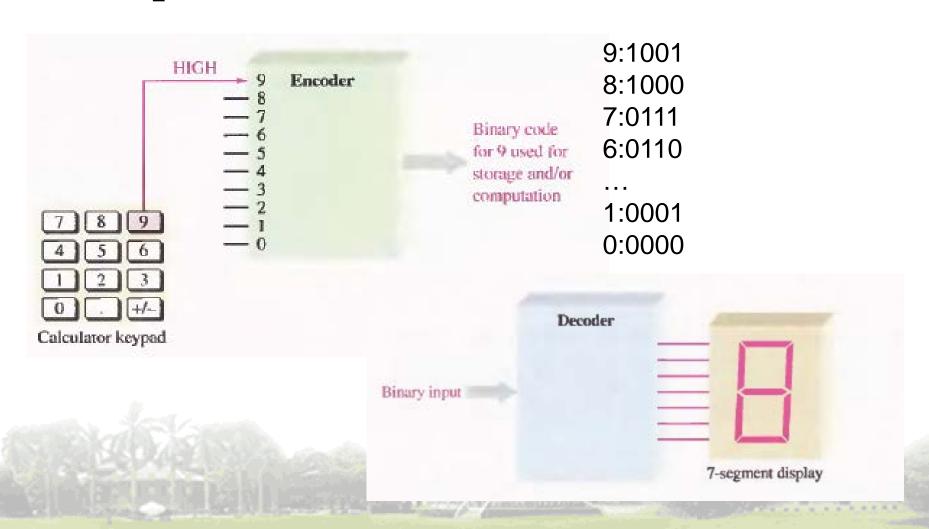
മ്പ്രാണം Comparator



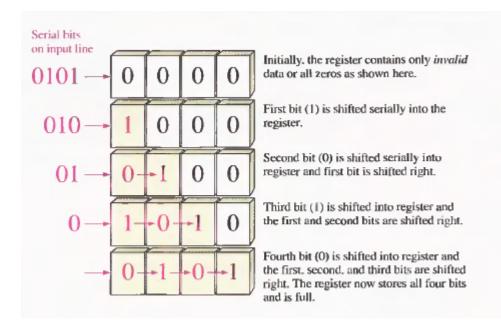
Brample. Adder

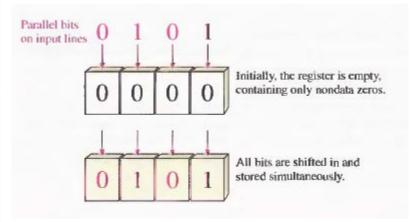


Encoder and decoder

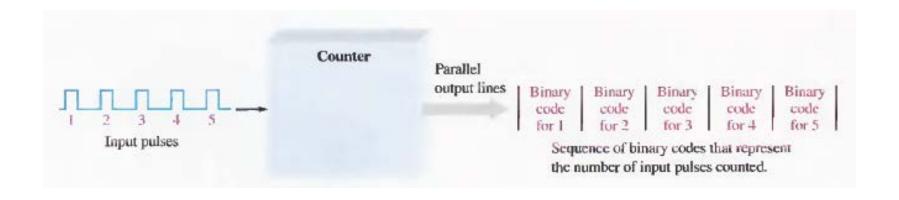


ള്ളായ്യാള്ള. Storage





Grample. Counter



1-4 Overview of Integrated Circuits

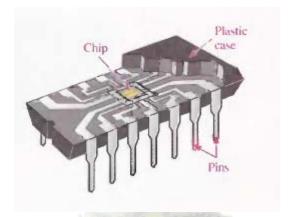
- Fixed-function Integrated Circuits
- Programmable Logic Circuits

Fixed-function Integrated Circuits

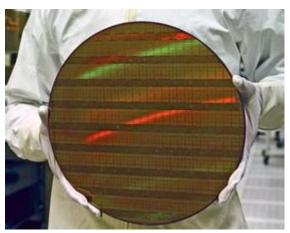
Fixed-function integrated circuits

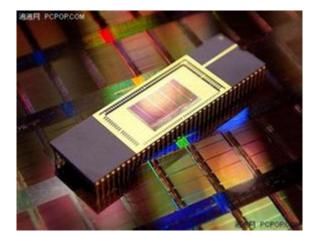
- Constructed on a single small chip of silicon
- The logic functions are set by the manufacturer
- The logic cannot be altered







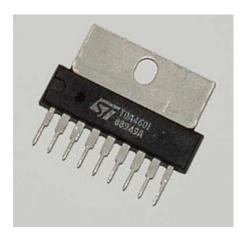






IC Packages

- SIP: Single in-line package
- DIP: Dual in-line package
- SMT: Surface-mount technology
 - SOIC: small-outline IC
 - PLCC: Plastic leaded chip carrier
 - LCCC: Leadless ceramic chip carrier
 - SSOP: Shrink small-outline package
 - TSSOP: Thin shrink small-outline package
 - TVSOP: Thin very small-outline package
 - BGA: ball grid array







End view

(a) SOIC with "gull-wing" leads



End view

(b) PLCC with J-type leads



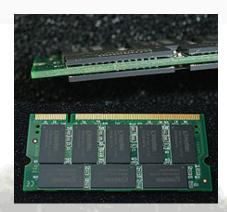


End view

(c) LCCC with no leads (contacts are part of case)



Bottom view of an Intel Embedded Pentium MMX, showing the blobs of solder



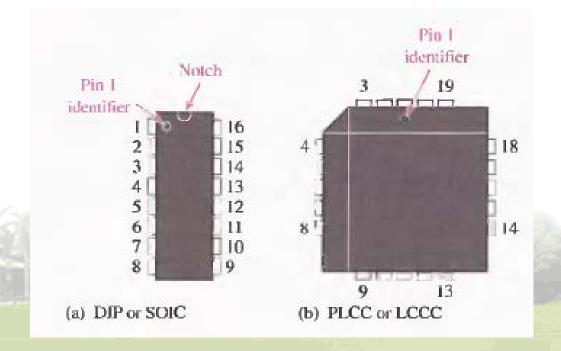
BGA ICs assembled on a PCB



Intel Mobile Celeron in a BGA2 package (FCBGA-479

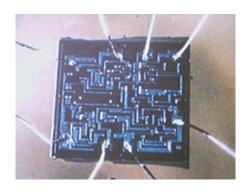
Pin Numbering

- Pin 1 is indicated by an identifier
- A small dot, a notch, or a beveled edge
- The dot is always next to pin 1.

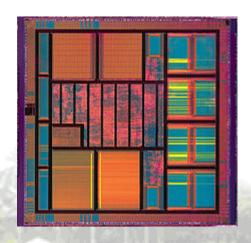


Complexity Classifications for Fixed-Function ICs

- Small-scale integration (SSI)
 - <10 equivalent gate circuits on a single chip
- Medium-scale integration (MSI)
 - $-10 \sim 100$
- Large-scale integration (LSI)
 - 100~10000
- Very large-scale integration (VLSI)
 - 10,000~100,000
- Ultra large-scale integration (ULSI)
 - ->1000,000



A small-scale integrated circuit die, with bond wires attached



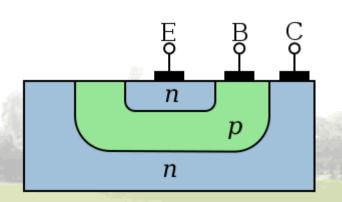
A VLSI integrated-circuit die

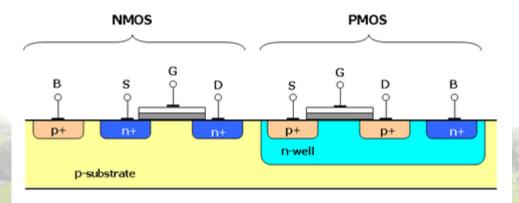
Semiconductor manufacturing processes

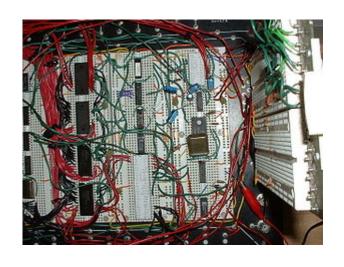
- •10 μm 1971
- •3 μm 1975
- •1.5 μm 1982
- •1 μm 1985
- •800 nm (.80 μm) 1989
- •600 nm (.60 μm) 1994
- •350 nm (.35 μm) 1995
- •250 nm (.25 μm) 1998
- •180 nm (.18 µm) 1999
- •130 nm (.13 μm) 2000
- •90 nm 2002
- •65 nm 2006
- •45 nm 2008
- •32 nm 2010
- •22 nm 2012
- •14 nm approx. 2014
- •10 nm approx. 2015
- •7 nm approx. 2020
- •5 nm approx. 2022

Integrated Circuit Technologies

- CMOS (Complementary Metal-Oxide Semiconductor)
 - Implemented with MOSFETs (Metal-Oxide Semiconductor Field-Effect Transistors)
- TTL (Transistor-Transistor Logic)
 - With bipolar junction transistors
- BiCMOS
 - Combination of both CMOS and TTL







A Motorola 68000-based computer with various TTL chips mounted on protoboards



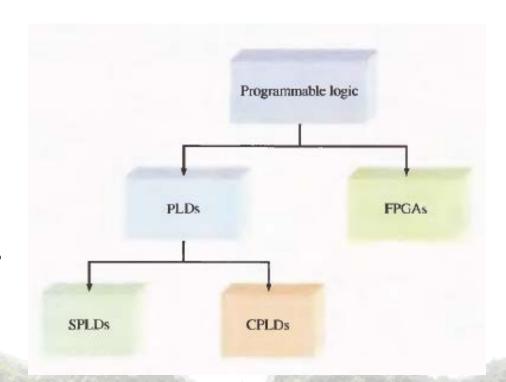
A micro ATX motherboard with some faulty capacitors

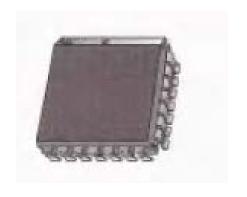
Programmable Logic Circuits

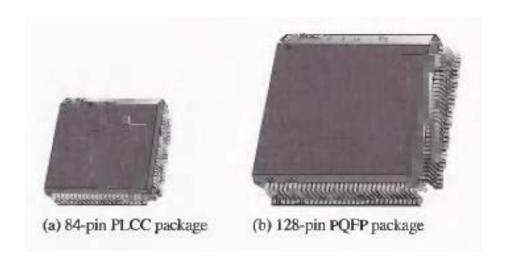
Types of Programmable Logic Devices

- PLD: Programmable Logic Device
- FPGA: Field
 Programmable Gate

 Array
- SPLD: Simple PLD
- CPLD: Complex PLDs



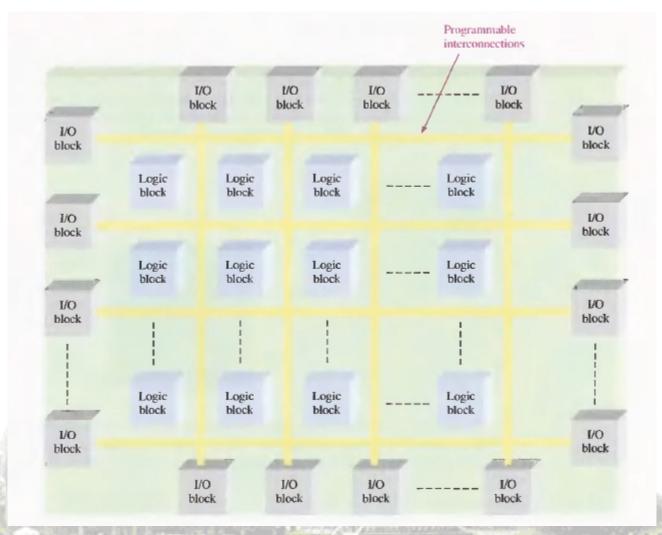




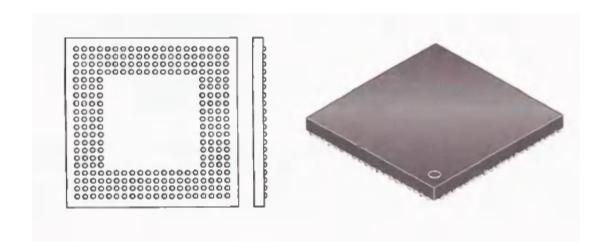
Typical package of SPLD

Typical CPLD packages

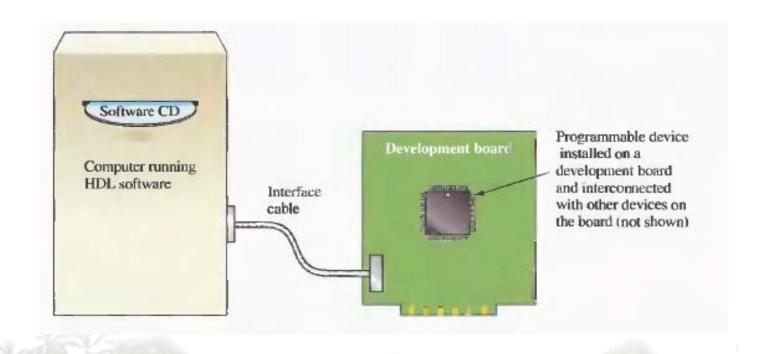
Basic structure of an FPGA

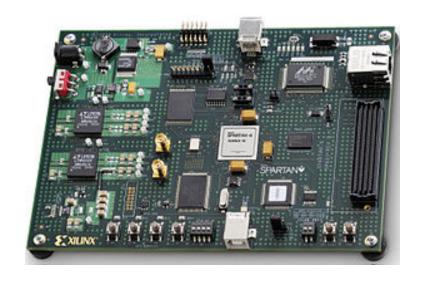


A typical ball-grid array package configuration



The Programming Process





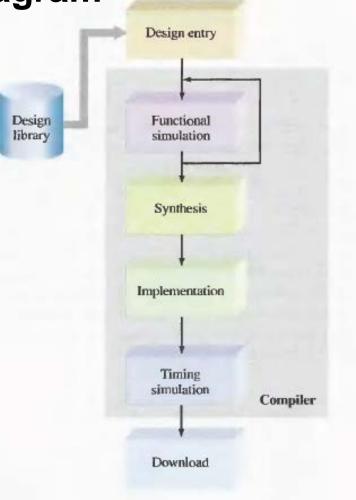


An example of a Xilinx Spartan 6 FPGA programming/evaluation board

An Altera Stratix IV GX FPGA

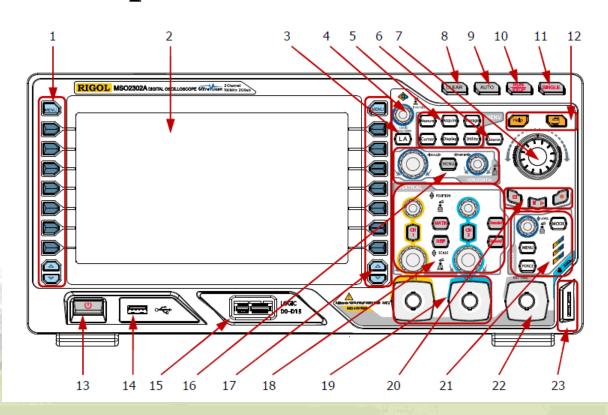
Basic programmable logic design flow



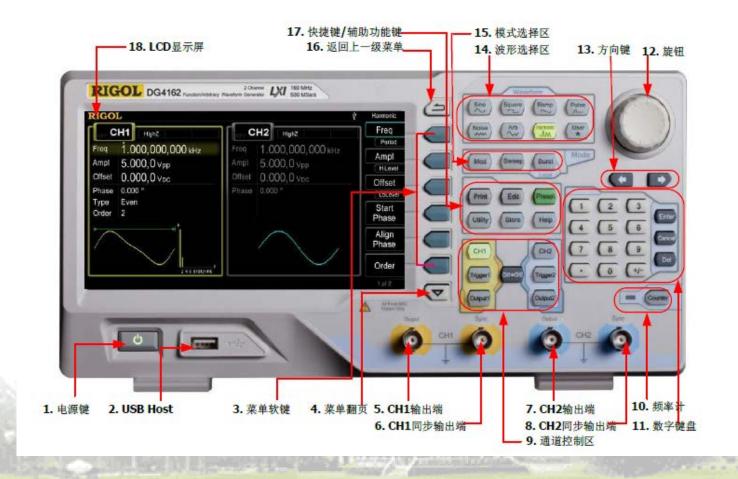


1-5 Test and Measurement Instruments

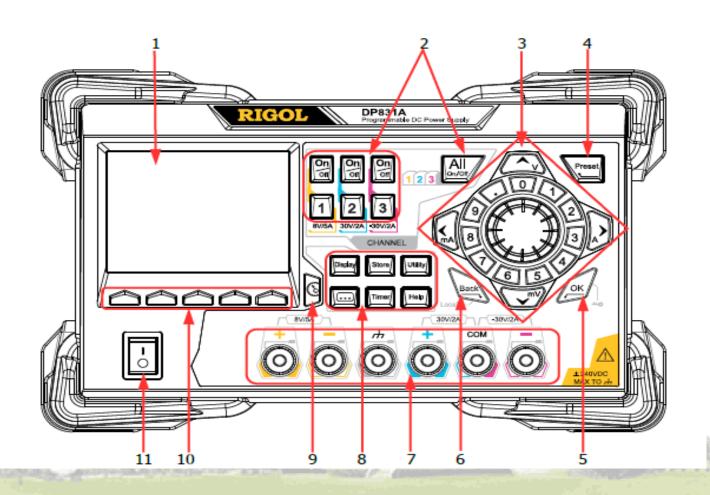
Oscilloscope



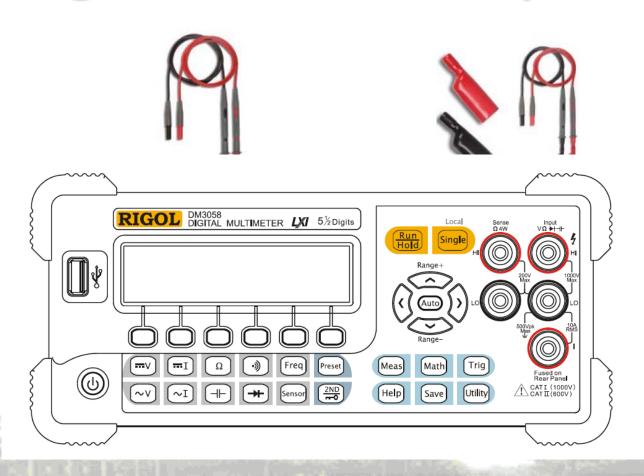
Signal generators



DC Power Supply



Digital Multimeter (DMM)



Summary

- Analog and digital
- Positional number systems
- Some basic concepts in digital design
- Basic logic operation
- Brief introduction of IC
- Test and measure instruments

HW

- Page 12 (Edition 10)
 - **-** 7
 - **–** 11
 - **12**